MSKSEMI 美森科













ESD

TVS

TSS

MOV

GDT

PLED

PESD0402MS05-MS

Product specification





PESD0402MS05-MS

FEATURES

- Ultra-Low capacitance:0.05pF(typ.)
- Low leakage current(<10nA)
- Fast response time(<1ns)
- Bi-directional, single line protection
- IEC 61000-4-2 (ESD Air): 15kV
- IEC 61000-4-2 (ESD Contact): 8kV

MACHANICAL DATA

- 0402
- Packaging: Tape and Reel
- Reel size: 7 inch
- 10000PCS/Reel

APPLICATIONS

- USB 3.0/3.1
- HDMI 1.3/ 1.4/2.0
- RF Antenna
- SATA and eSATA Interface

Reference News

PACKAGE OUTLINE	PIN CONFIGURATION
0402	



Limiting Values(TA = 25 °C, unless otherwise specified)

Symbol	Parameter	Conditions	Min	Мах	Unit
Vesd	Electrostatic Discharge Voltage	IEC 61000-4-2; Contact Discharge	-	8	^k ∨
	IEC 61000-4-2; Air Discharge	-	15	^k ∨	
TA	Operating Temperature Range	-	-55	125	°C
T _{stg}	Storage Temperature Range	-	-40	85	°C

ELECTRICAL CHARACTERISTICS (Tamb=25°C)

Symbol	Parameter	Conditions	Min	Тур.	Max	Unit
VDC	Continuous Operating Voltage	-	-	-	5	V
	VT Trigger Voltage	IEC61000-4-2 8kV		450		
VI		contact discharge	-	450	-	V
	Clamping Voltage	IEC61000-4-2 8kV		4.0		
VC	olamping voltage	contact discharge	-	40	-	V
	Leakage Current	DC 5V shall be applied				_
IL Leakage	Leakage Guilent	on component	-	-	10	nA
CJ	Capacitance	Measured at 10MHz	-	0.05	-	P F



Typical Characteristics

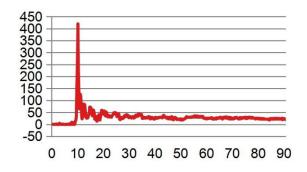


Fig. 1 Typical ESD Response (IEC 61000-4-2, 8kV contact discharge)

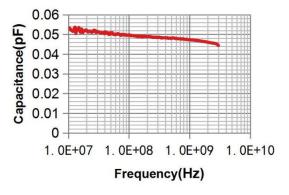


Fig.2 Typical Device Capacitance VS. Frequency

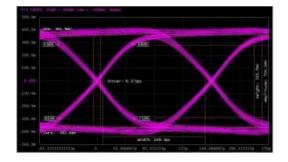
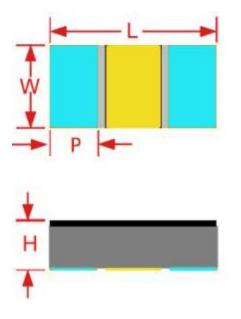


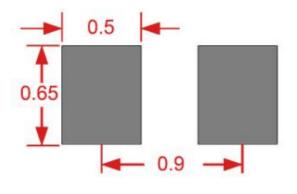
Fig.3 HDMI 2.0 Mask at 6.0 Gbps



PACKAGE MECHANICAL DATA



Recommended Solder Pad Footprint



Notes: This solder pad layout is for reference purposes only.

Dimension	Unit: Millimeters		
	Min	Max	
L	0.90	1. 10	
W	0.42	0.62	
р	0. 15	0.35	
Н	0.25	0.45	

REEL SPECIFICATION

P/N	PKG	QTY
PESD0402MS05-MS	0402	10000

Attention

■ Any and all MSKSEMI Semiconductor products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your MSKSEMI Semiconductor representative nearest you before using any MSKSEMI Semiconductor products described or contained herein in such applications.

MSKSEMI Semiconductor assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all MSKSEMI Semiconductor products described or contained herein.

Specifications of any and all MSKSEMI Semiconductor products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

MSKSEMI Semiconductor. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with someprobability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits anderror prevention circuits for safedesign, redundant design, and structural design.

■ In the event that any or all MSKSEMI Semiconductor products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from theauthorities concerned in accordance with the above law.

■ No part of this publication may be reproduced or transmitted in any form or by any means, electronic or

mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of MSKSEMI Semiconductor.

Information (including circuit diagrams and circuit parameters) herein is for example only ; it is not guaranteed for volume production. MSKSEMI Semiconductor believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements intellectual property rights or other rights of third parties.

Any and all information described or contained herein are subject to change without notice due to

product/technology improvement, etc. Whendesigning equipment, referto the "Delivery Specification" for the MSKSEMI Semiconductor productthat you intend to use.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for ESD Suppressors / TVS Diodes category:

Click to view products by MSKSEMI manufacturer:

Other Similar products are found below :

60KS200C D18V0L1B2LP-7B D5V0F4U5P5-7 NTE4902 P4KE27CA P6KE11CA P6KE8.2A SA60CA SA64CA SMBJ12CATR SMBJ33CATR SMBJ6.5A SMBJ8.0A ESD101-B1-02ELS E6327 ESD112-B1-02EL E6327 ESD7451N2T5G 19180-510 CPDT-5V0USP-HF 3.0SMCJ33CA-F 3.0SMCJ36A-F HSPC16701B02TP JANTX1N6126A D3V3Q1B2DLP3-7 D55V0M1B2WS-7 SCM1293A-04SO ESD200-B1-CSP0201 E6327 SM12-7 CEN955 W/DATA VESD12A1A-HD1-GS08 CPDQC5V0-HF D1213A-01LP4-7B ESD101-B1-02EL E6327 AOZ8808DI-03 5KP15A 5KP48A 5KP90A ESD3V3D7-TP 15KPA36A-LF P4KE56CA P4KE68A P4KE91CATR P6KE120A P6KE13CA P6KE43CA P6KE6.8CA P6KE8.2 P6SMBJ20CA JANTX1N6072A SR2835ESKG SA90CA